

## N-Channel 40-V (D-S), 175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	$(on)$ $(\Omega)$ $I_D(A)^{a, c}$ $Q_g(T)$			
40	0.016 at V <sub>GS</sub> = 10 V	20	15.6 nC		
	$0.018$ at $V_{GS} = 4.5 \text{ V}$	20	15.0110		

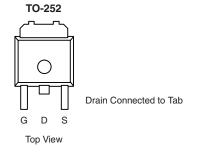
#### **FEATURES**

- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested

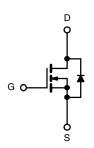


#### **APPLICATIONS**

- · LCD TV Inverter
- Secondary Synchronous Rectification



Ordering Information: SUD50N04-16P-E3 (Lead (Pb)-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	$T_A = 25  ^{\circ}C$ , unles	s otherwise no	oted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	40	V		
Gate-Source Voltage		$V_{GS}$	± 16	v	
	T <sub>C</sub> = 25 °C		20 <sup>c</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 100 °C	I.	20 <sup>c</sup>		
Continuous Diain Current (1) = 150 C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	9.8 <sup>b</sup>		
	T <sub>A</sub> = 100 °C		6.8 <sup>b</sup>	Α Α	
Pulsed Drain Current		I <sub>DM</sub>	50	7	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		20 <sup>c</sup>		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.5 <sup>b</sup>		
Single Pulse Avalanche Current		I <sub>AS</sub>	20		
Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
	T <sub>C</sub> = 25 °C	P <sub>D</sub>	35.7		
Maximum Power Dissipation	T <sub>C</sub> = 100 °C		17.8	w	
	T <sub>A</sub> = 25 °C	гD	3.1 <sup>b</sup>	- vv	
	T <sub>A</sub> = 100 °C		1.5 <sup>b</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	$R_{thJA}$	40	50	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	3.4	5.3		

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. Package limited.

## SUD50N04-16P

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static						L	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V, } I_{D} = 250  \mu\text{A}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			38		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5.4			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	0.8		2.2	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA	
Zana Oata Waltana Buil O	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V			1	1 20 μA	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 100 °C			20		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
Drain-Source On-State Resistance <sup>a</sup>	` '	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0125	0.016	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.014	0.018		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		58		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			1655		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		200			
Reverse Transfer Capacitance	C <sub>rss</sub>			152			
Tatal Oaks Observe	0	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		39.2	60		
Total Gate Charge	Qg			15.6	24	nC	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 30 \text{ A}$		4.2			
Gate-Drain Charge	$Q_{gd}$			5.5			
Gate Resistance	$R_{g}$	f = 1 MHz		2.1	3.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			19	30	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 0.66 \Omega$ $I_D \cong 30 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		120	180		
Turn-Off Delay Time	t <sub>d(off)</sub>			40	60		
Fall Time	t <sub>f</sub>			36	55		
Turn-On Delay Time	t <sub>d(on)</sub>			8	16		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 0.66 $\Omega$		22	35		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 30 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		24	36		
Fall Time	t <sub>f</sub>			8	16		
<b>Drain-Source Body Diode Characteris</b>	tics						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			20	А	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 10 A		0.84	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			25	38	ns	
Body Diode Reverse Recovery Charge Q <sub>rr</sub>		l <sub>F</sub> = 20 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		22	33	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$[1 - 20 A, a / at - 100 A / \mu s, 1] = 25 C$		15		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			10			

#### Notes:

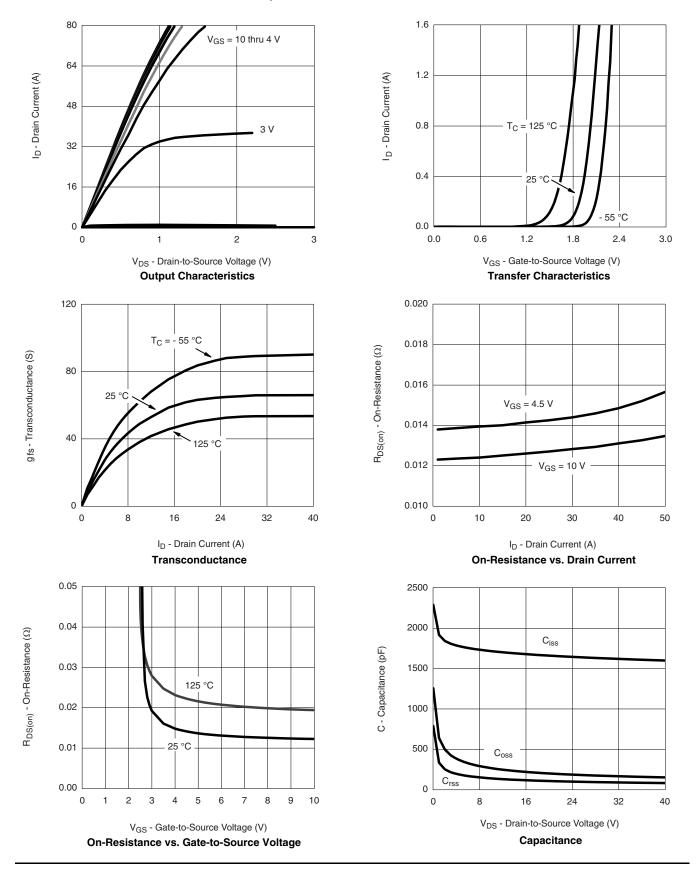
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.



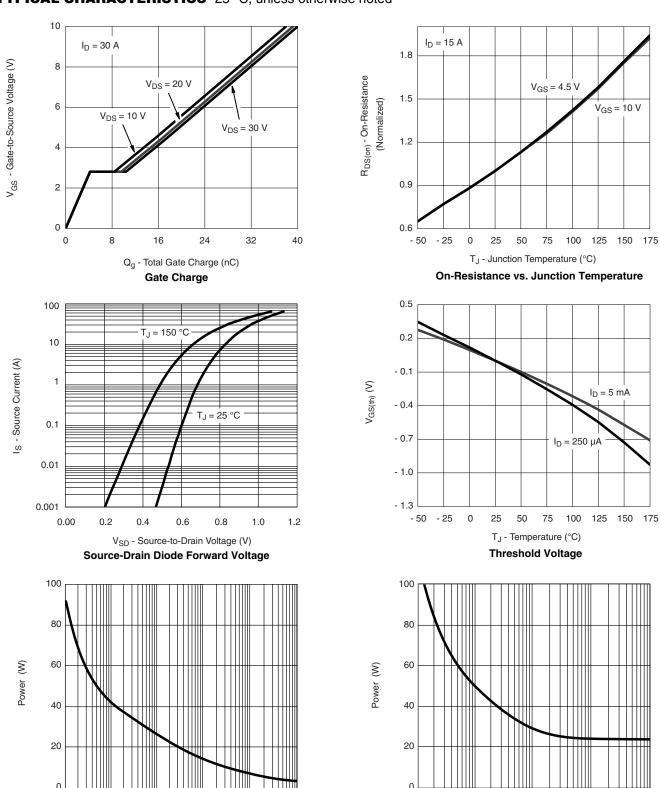
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0.001

0.01

0.1

1

Time (s)

Single Pulse Power, Junction-to-Ambient

10

100

10

0.01

0.001

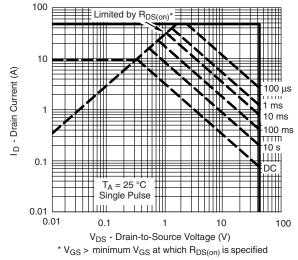
0.1

Time (s)

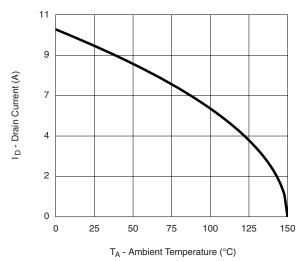
Single Pulse Power, Junction-to-Case



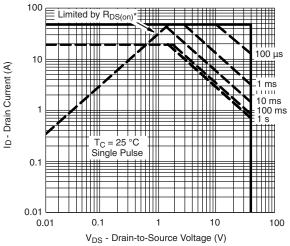
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



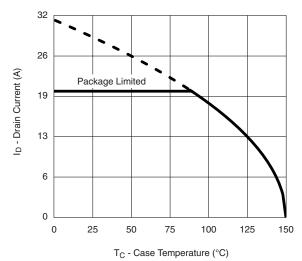
#### Safe Operating Area, Junction-to-Ambient



Current Derating\*\*, Junction-to-Ambient



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified **Safe Operating Area, Junction-to-Case** 



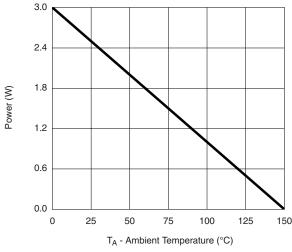
Current Derating\*\*, Junction-to-Case

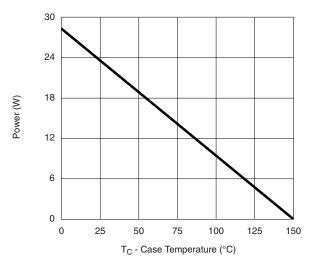
<sup>\*\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



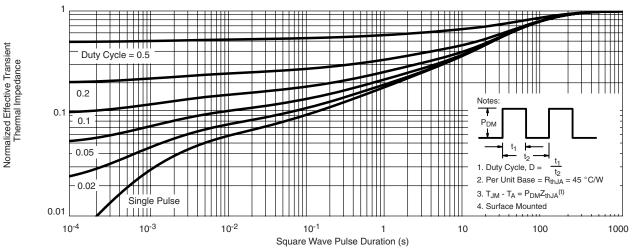


Power Derating\*, Junction-to-Ambient Power Derating\*, Junction-to-Case

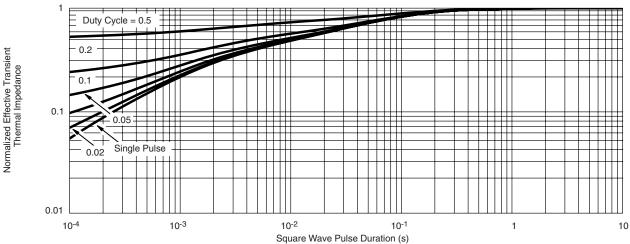
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 175$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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